



General Description

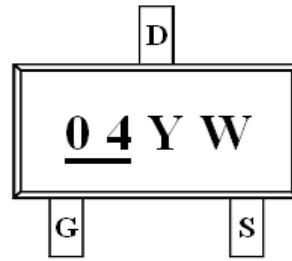
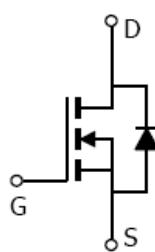
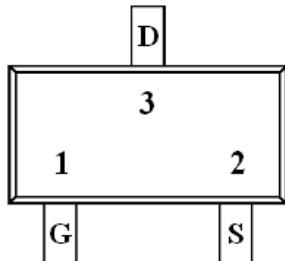
AFN2304A, N-Channel enhancement mode MOSFET, uses Advanced Trench Technology to provide excellent $R_{DS(ON)}$, low gate charge.

These devices are particularly suited for low voltage power management, such as smart phone and notebook computer and other battery powered circuits, and low in-line power loss are needed in commercial industrial surface mount applications.

Features

- 30V/2.6A, $R_{DS(ON)}=82m\Omega @ V_{GS}=10V$
- 30V/2.0A, $R_{DS(ON)}=108m\Omega @ V_{GS}=4.5V$
- Super high density cell design for extremely low $R_{DS(ON)}$
- Exceptional on-resistance and maximum DC current capability
- SOT-23 package design

Pin Description (SOT-23)



Application

- Portable Equipment
- Battery Powered System
- Net Working System

Pin Define

Pin	Symbol	Description
1	G	Gate
2	S	Source
3	D	Drain

Ordering Information

Part Ordering No.	Part Marking	Package	Unit	Quantity
AFN2304AS23RG	<u>04</u> YW	SOT-23	Tape & Reel	3000 EA

- ※ 04 parts code
- ※ Y year code (0 ~ 9)
- ※ W week code (A ~ Z = 1 ~ 26 / a ~ z = 27 ~ 52)
- ※ AFN2304AS23RG : 7" Tape & Reel ; Pb- Free ; Halogen- Free



**Alfa-MOS
Technology**

**AFN2304A
30V N-Channel
Enhancement Mode MOSFET**

Absolute Maximum Ratings

($T_A=25^\circ\text{C}$ Unless otherwise noted)

Parameter	Symbol	Typical	Unit
Drain-Source Voltage	V_{DSS}	30	V
Gate -Source Voltage	V_{GSS}	± 20	V
Continuous Drain Current($T_J=150^\circ\text{C}$)	I_D	3.6	A
$T_A=70^\circ\text{C}$		2.0	
Pulsed Drain Current	I_{DM}	10	A
Continuous Source Current(Diode Conduction)	I_S	1.6	A
Power Dissipation	P_D	1.25	W
$T_A=70^\circ\text{C}$		0.8	
Operating Junction Temperature	T_J	150	$^\circ\text{C}$
Storage Temperature Range	T_{STG}	-55/150	$^\circ\text{C}$
Thermal Resistance-Junction to Ambient	$R_{\theta JA}$	120	$^\circ\text{C}/\text{W}$

Electrical Characteristics

($T_A=25^\circ\text{C}$ Unless otherwise noted)

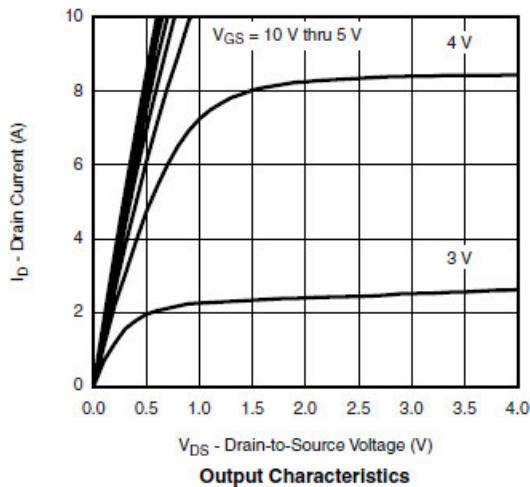
Parameter	Symbol	Conditions	Min.	Typ	Max.	Unit
Static						
Drain-Source Breakdown Voltage	$V_{(BR)DSS}$	$V_{GS}=0\text{V}, I_D=250\mu\text{A}$	30			V
Gate Threshold Voltage	$V_{GS(\text{th})}$	$V_{DS}=V_{GS}, I_D=250\mu\text{A}$	1.0		2.5	
Gate Leakage Current	I_{GSS}	$V_{DS}=0\text{V}, V_{GS}=\pm 20\text{V}$			± 100	nA
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS}=30\text{V}, V_{GS}=0\text{V}$			1	uA
		$V_{DS}=30\text{V}, V_{GS}=0\text{V}$ $T_J=85^\circ\text{C}$			30	
On-State Drain Current	$I_{D(\text{on})}$	$V_{DS} \geq 5\text{V}, V_{GS}=4.5\text{V}$	30			A
Drain-Source On-Resistance	$R_{DS(\text{on})}$	$V_{GS}=10\text{V}, I_D=2.6\text{A}$		72	82	m Ω
		$V_{GS}=4.5\text{V}, I_D=2.0\text{A}$		95	108	
Forward Transconductance	g_{FS}	$V_{DS}=10\text{V}, I_D=6.1\text{A}$		20		S
Diode Forward Voltage	V_{SD}	$I_S=1.7\text{A}, V_{GS}=0\text{V}$		0.8	1.2	V
Dynamic						
Total Gate Charge	Q_g	$V_{DS}=15\text{V}, V_{GS}=4.5\text{V}$ $I_D=3.6\text{A}$		2.3	3	nC
Gate-Source Charge	Q_{gs}			1.0		
Gate-Drain Charge	Q_{gd}			0.6		
Input Capacitance	C_{iss}	$V_{DS}=15\text{V}, V_{GS}=0\text{V}$ $f=1\text{MHz}$		280		pF
Output Capacitance	C_{oss}			40		
Reverse Transfer Capacitance	C_{rss}			20		
Turn-On Time	$t_{d(\text{on})}$	$V_{DD}=15\text{V}, R_L=15\Omega$ $I_D=1.0\text{A}, V_{GEN}=10\text{V}$		10	15	ns
	t_r			12	20	
Turn-Off Time	$t_{d(\text{off})}$			15	25	
	t_f			10	15	



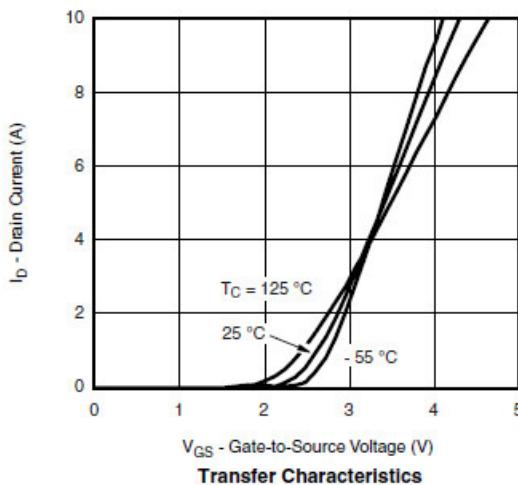
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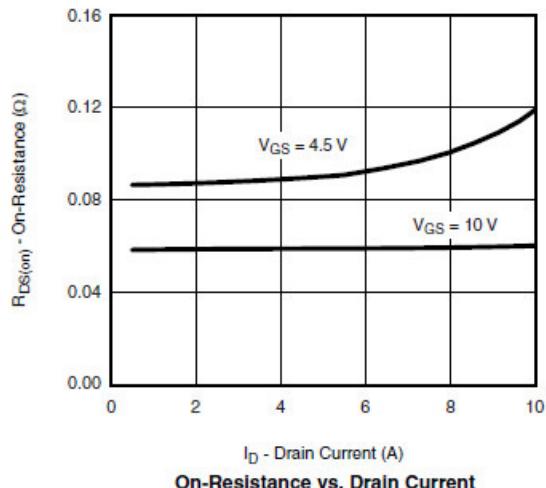
Typical Characteristics



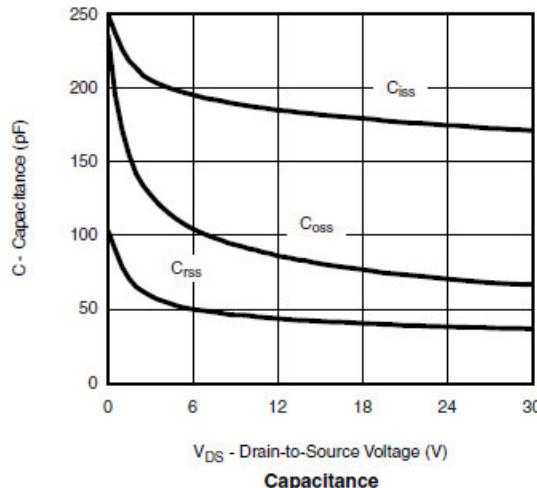
Output Characteristics



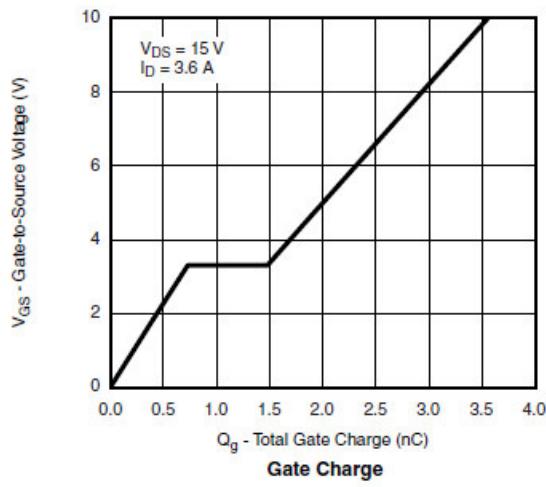
Transfer Characteristics



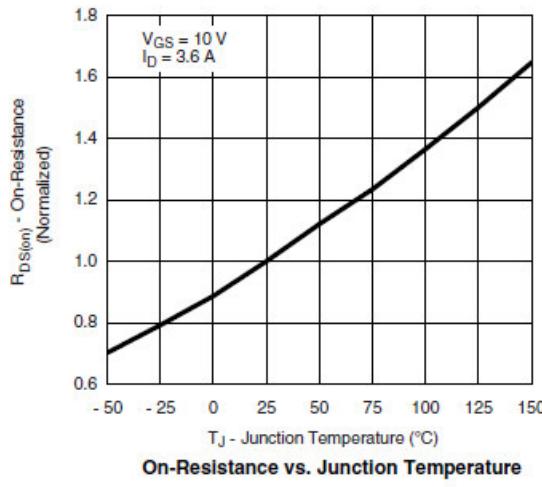
On-Resistance vs. Drain Current



Capacitance



Gate Charge



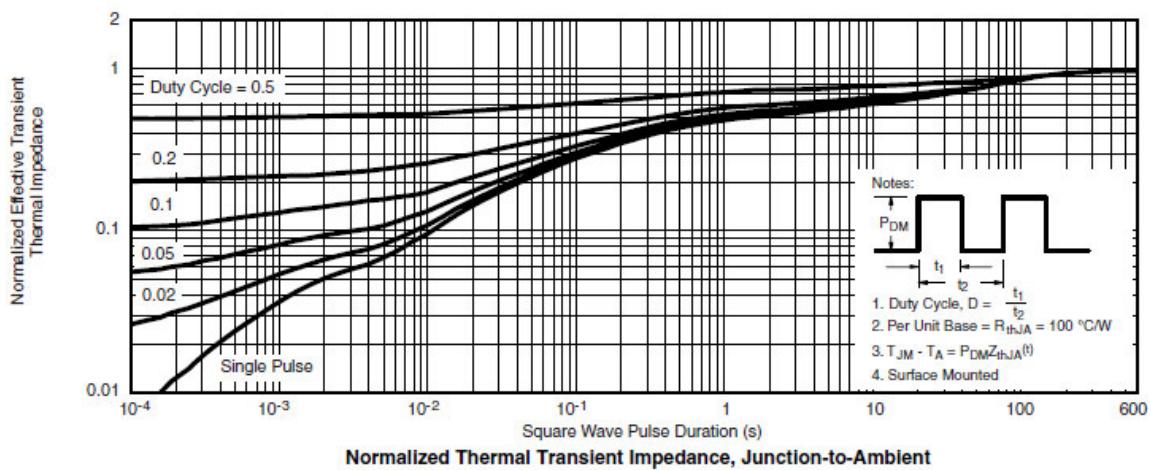
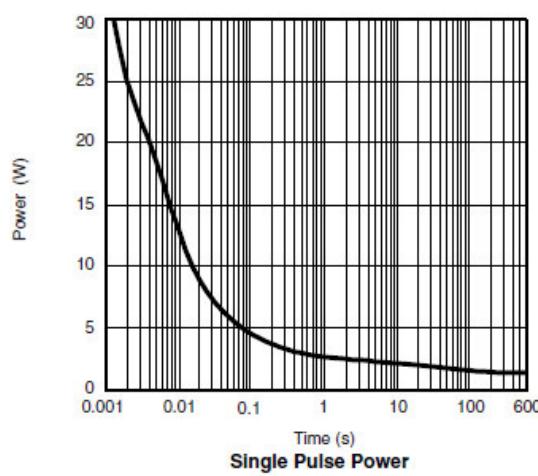
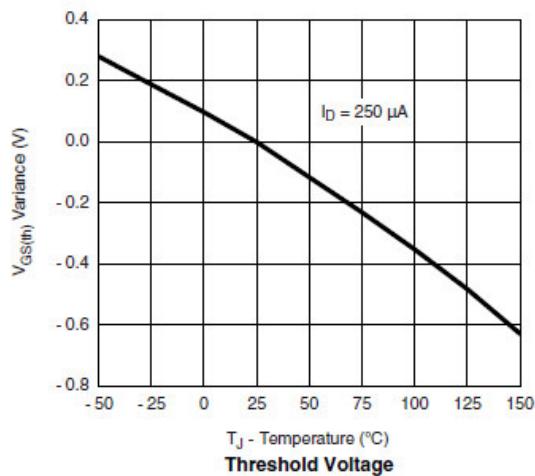
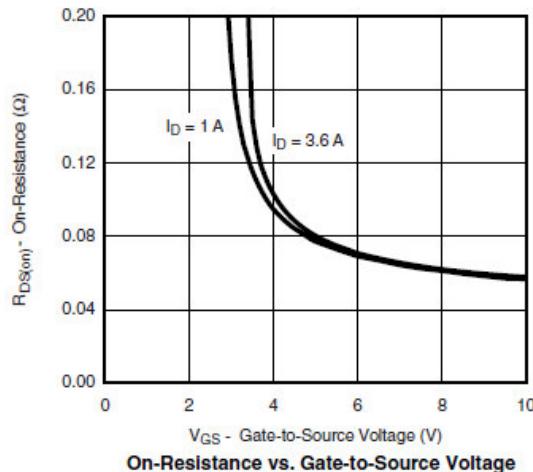
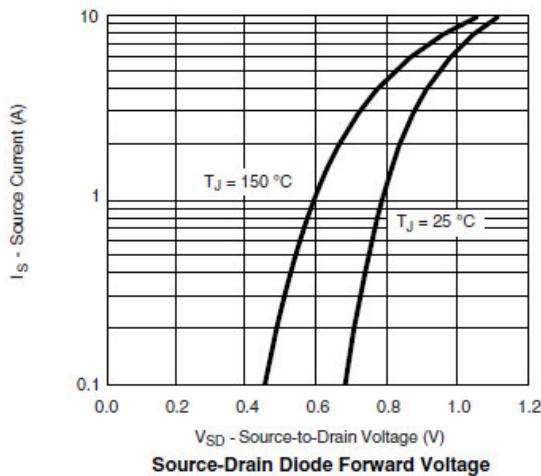
On-Resistance vs. Junction Temperature



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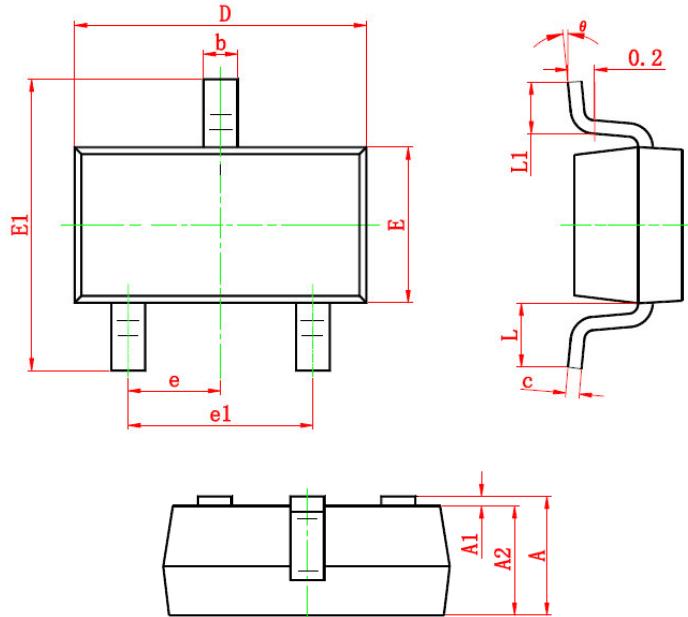




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Package Information (SOT-23)



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	0.900	1.200	0.035	0.043
A1	0.000	0.100	0.000	0.004
A2	0.900	1.100	0.035	0.039
b	0.300	0.500	0.012	0.020
c	0.080	0.150	0.003	0.006
D	2.800	3.000	0.110	0.118
E	1.200	1.400	0.047	0.055
E1	2.250	2.550	0.089	0.100
e	0.950 TYP		0.037 TYP	
e1	1.800	2.000	0.071	0.079
L	0.550 REF		0.022 REF	
L1	0.300	0.500	0.012	0.020
θ	0°	8°	0°	6°

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